DATA	SHEET

PART NO. : LQR5UW5C621G-BIC

REV: <u>A/0</u>

CUSTOMER'S APPROVAL:

DCC:

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please pay enough care in the handling.

(HBM).

2.Tolerance is ±0.25mm(0.010 ")Unless otherwise specified.

4.Lead spacing is measured where the leads emerge from the package.

6.highlight <-1500V the led canwithstand the max static level whenassembling or operation

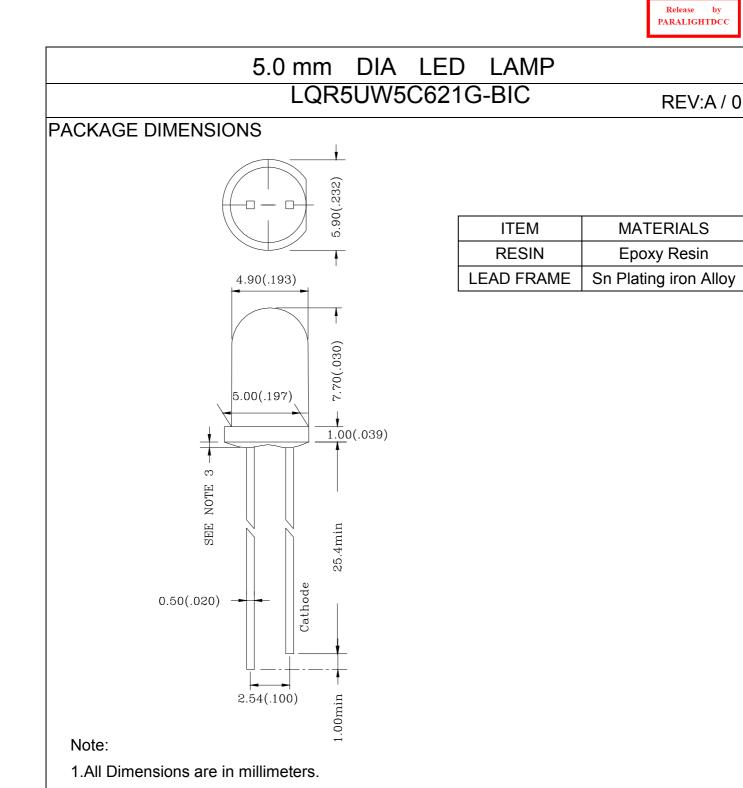
7. The lamps have sharp and hard points that may injure human eyes or fingers etc., so

3.Protruded resin under flange is 1.5mm(0.059 ") max.

5. Specification are subject to change without notice

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5.0 mm DIA LED LAMP LQR5UW5C621G-BIC

FEATURES

- * High-brightness
- * High reliability
- * Low-voltage characteristics
- * Narrow view angle
- * Pb FREE Products
- * RoHS Compliant

CHIP MATERIALS

- * Dice Material : CREE CHIP
- * Light Color : White
- * Lens Color : Water Clear

ABSOLUTE MAXIMUM RATING:(Ta=25°C)

SYMBOL	DESCRIPTION	White	UNIT	
PD	Power Dissipation Per Chip	120	mW	
VR	Reverse Voltage Per Chip	5	V	
lF	Average Forward Current Per Chip	30	mA	
IFP	Pulse Forward Current	100	mA	
-	Derating Linear From 25°C Per Chip	0.40 mA/°C		
Topr	Operating Temperature Range	-25°C to 85°C		
Tstg	Storage Temperature Range	-25°C to 85°C		

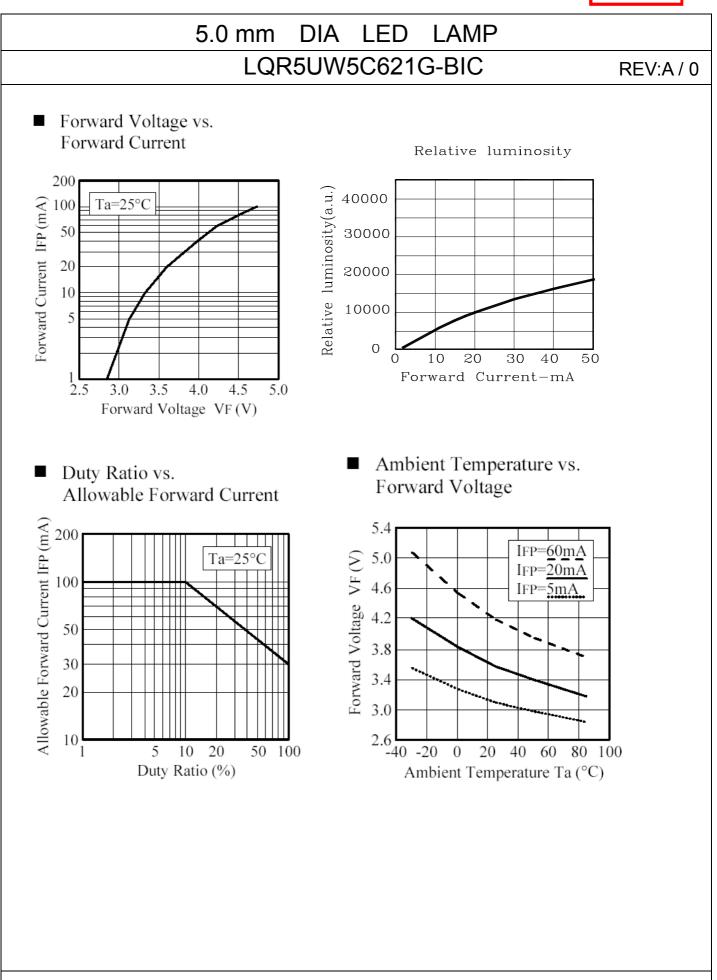
ELECTRO-OPTICAL CHARACTERISTICS:(Ta=25°C)

SYMBOL	DESCRIPTION	DESCRIPTION TEST MI		TYP.	MAX.	UNIT
VF	Forward Voltage	IF = 20mA		3.0	4.0	V
IR	Reverse Current	VR = 5V			100	μA
201/2	Half Intensity Angle	IF = 20mA		10		deg
IV	Luminous Intensity	IF = 20mA		10000		mcd
Х	Chromaticity Coordinates	IF = 20mA		0.29		
Y		IF = 20mA		0.30		



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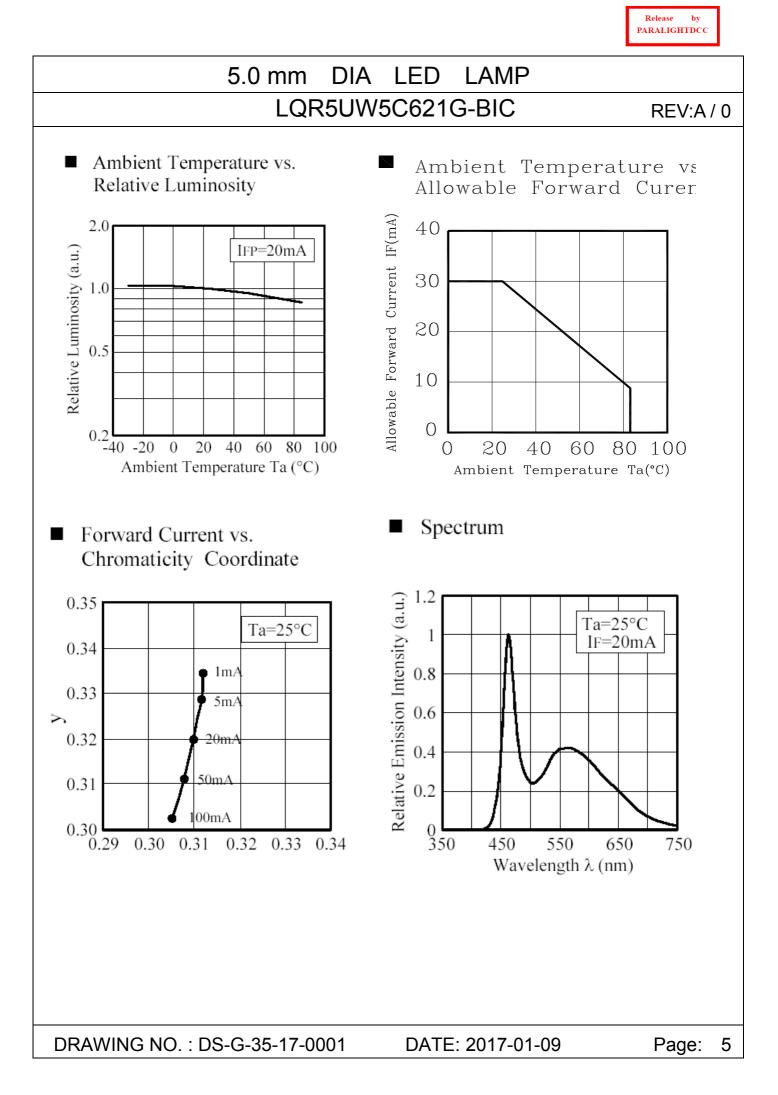


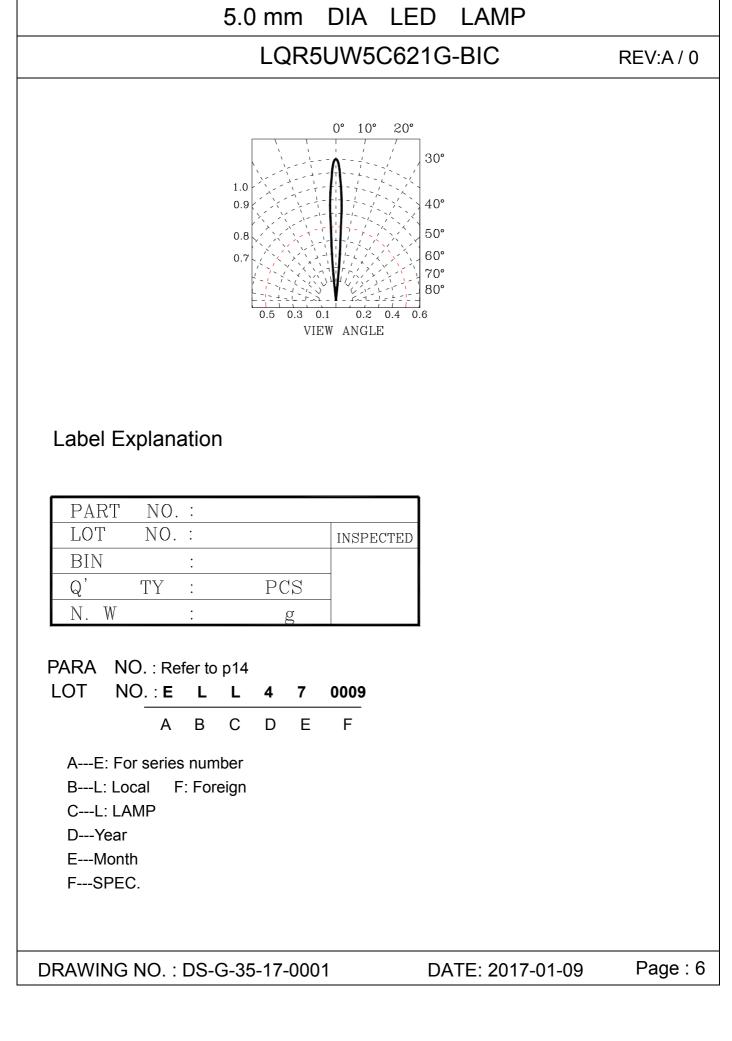
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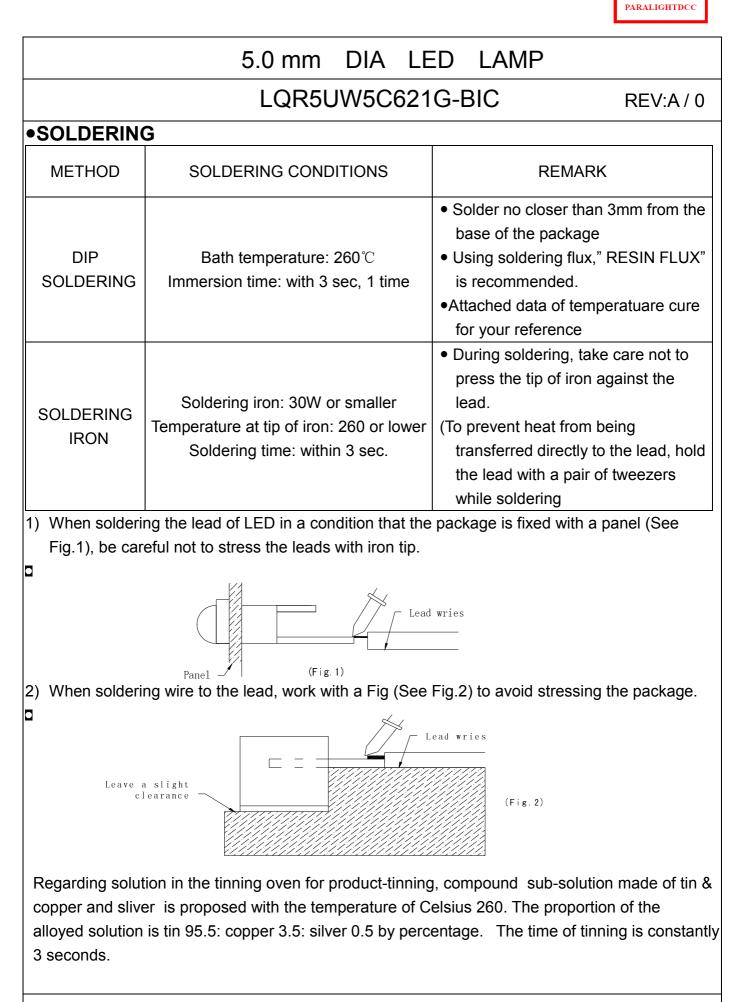
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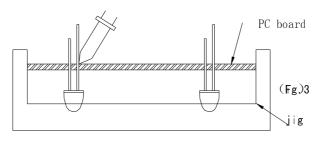
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avoid steering the leads (See Fig.3).

4) Repositioning after soldering should be avoided as much as possible. If inevitable, be sure to preserve the soldering conditions with irons stated above: select a best-suited method that assures the least stress to the LED.

5.0 mm DIA LED LAMP

3) Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to

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 Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

STORAGE

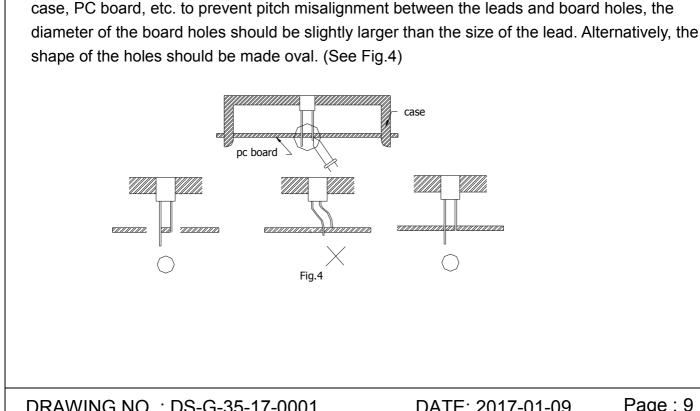
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- 1) The LEDs should be stored at 30° C or less and 70% RH or less after being shipped from PARA and the storage life limits are 3 months .
- 2) PARA LED lead frames are comprised of a stannum plated iron alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

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•LED MOUNTING METHOD 4) When mounting the LED by using a case, as shown Fig.4, ensure that the mounting holds on the PC board match the pitch of the leads correctly-tolerance of dimensions of the respective components including the LED should be taken into account especially when designing the

4) Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current . Criteria : (VF>2.0V at IF=0.5mA)

STATIC ELECTRICITY

recommended).

1) Static electricity or surge voltage damages the LEDs. It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

5.0 mm DIA LED

- 2) All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- 3) When inspecting the final products in which LEDs were assembled, it is recommended to check
- whether the assembled LEDs are damaged by static electricity or not. It is easy to find

static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is

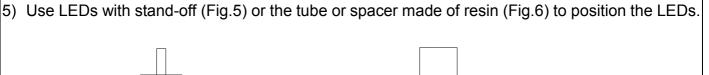
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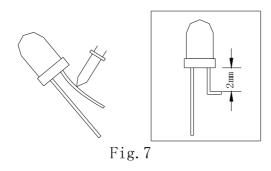
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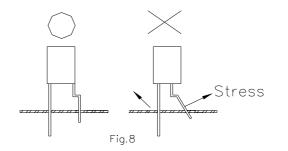


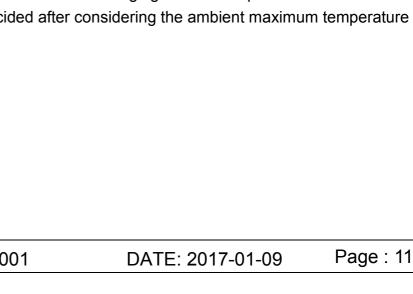
•FORMED LEAD

1) The lead should be bent at a point located at least 2mm away from the package. Bending should be performed with base fixed means of a jig or pliers (Fig.7)



- 2) Forming lead should be carried our prior to soldering and never during or after soldering.
- 3) Form the lead to ensure alignment between the leads and the hole on board, so that stress against the LED is prevented. (Fig.8)





- 1) Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- 2) The operating current should be decided after considering the ambient maximum temperature of LEDs.

HEAT GENERATION

Fig.9 Tensile strength (@Room Temperature) If the force is 1kg or less, there will be no problem. (Fig.10)

Fig.10

•LEAD STRENGTH

1) Bend strength

Do not bend the lead more than twice. (Fig.9)

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•CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- 2) When washing is required, refer to the following table for the proper chemical to be sued.
- (Immersion time: within 3 minutes at room temperature.)

SOLVENT	ADAPTABILITY
Freon TE	\odot
Chlorothene	\times
Isopropyl Alcohol	\odot
Thinner	\times
Acetone	\times
Trichloroethylene	\times

NOTE: Influences of ultrasonic cleaning of the LED resin body differ depending on such factors as the oscillator output, size of the PC board and the way in which the LED is mounted. Therefore, ultrasonic cleaning should only be performed after confirming there is no problem by conducting a test under practical.

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 \odot --Usable \times --Do not use.

•OTHERS

- 1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- 3) The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- 4) User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from PARA. When defective LEDs are found, the User shall inform PARA directly before disassembling or analysis.
- 5) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- 6) The appearance and specifications of the product may be modified for improvement without notice.



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Bin Code List:

Luminous Intensity(IV), Unit:mcd@20mA					
Bin Code	Min	Max			
MB	6935	8090			
NA	8090	9710			
NB	9710	11330			
OA	11330	13595			
OB	13595	15860			

Tolerance of each bin are±15%

Forward Voltage (VF), Unit:v@20mA						
Bin Code	Min	Max				
V0	2.8	3.0				
V1	3.0	3.2				
V2	3.2	3.4				
V3	3.4	3.6				

Tolerance of each bin are $\pm 0.1V$

	WA5					A	.0		
Х	0.26	0.26	0.264	0.28	Х	0.28	0.264	0.283	0.296
Y	0.205	0.265	0.267	0.248	Y	0.248	0.267	0.305	0.276

5.0 mm DIA LED LAMP LQR5UW5C621G-BIC REV:A/0 LED Lamps: Part Number Rules $\underline{C} X \underline{X} X X^{-}$ Special code:by special L Х R X request only Example: A Stand for Para USA's new projects. Serial number Color of LED lens: (C= water clear, T=color transparent, W = white diffused, D=color diffused) Colours of light: (G:Gap Green E : GaAs/Gap Orange & Hi-effi-Red H : Gap Red SR,LR,UR : GaAlAs Red Y : GaAsP/Gap Yellow VG3 : GaAlInp Green HUR : GaAlInP Red LE,VE : GaAlInP Orange LY,UY,VY : GaAlInP Yellow SPG4,LPG4 : GaInN Green UB5 VB5 : GaInN Blue UB5,VB5 : GalnN Blue UW5,VW5 UWT : GalnN White PU4 : GalnN Purple) Diameter of LED lens Shapes of LED lens (R:round, E:ellipse, S:rectangular、F:super flux LED) Years of development:2006=F/2007=G/2008=H 2009=J/2010=K/2011=L/2012=M 2013=N/2014=O/2015=P L-LAMP products DATE: 2017-01-09

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